


0.6" Female -0.3" Male

- △1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- △2 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).
- △3 Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.). Contact material- BeCu; finish 10µ" Au over 100µ" Ni (min.).

<b>PC-DIP/DIP20-01 Drawing</b>		Status: Released	Scale: 3:1	Rev: C
 © 1998 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100	Drawing: P.Jasmin		Date: 12/8/89	
	File: PA- DIP/DIP20-01 DWG			ECO#